VBUS54FD-SD1



Vishay Semiconductors

4-Line BUS-Port ESD Protection Array - Flow Through Design

FEATURES

Compact chip level page CLP1007-5L

Low leakage current I_R < 0.1 μA

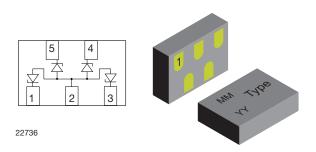
· Ideal for high speed data line like

ESD immunity acc. IEC 61000-4-2

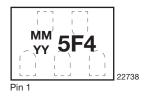
- HDMI, DisplayPort, eSATA

4-lines, unidirectional ESD protection array

• Low capacitance at $V_B = 0 V = 0.9 pF$ (typ.)



MARKING



click logo to get started.

5F4 = type codeMM = date code month YY = date code year

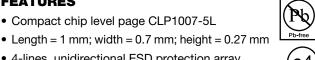
DESIGN SUPPORT TOOLS



ORDERING INFORMATION				
DEVICE NAME	ORDERING CODE	TAPED UNITS PER REEL (8 mm TAPE ON 7" REEL)	MINIMUM ORDER QUANTITY	
VBUS54FD-SD1	VBUS54FD-SD1-G4-08	10 000	10 000	

PACKAGE DATA						
DEVICE NAME	PACKAGE NAME	TYPE CODE	WEIGHT	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS	
VBUS54FD-SD1	CLP1007-5L	5F4	0.1 mg	MSL level 1 (according J-STD-020)	Peak temperature max. 260 °C	

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5; t_{P} = 8/20 $\mu\text{s};$ single shot	I _{PPM}	3	А
Peak pulse power	Acc. IEC 61000-4-5; $t_P = 8/20 \ \mu s$; single shot	P _{PP}	45	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses		± 15	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 15	ĸv
Operating temperature	Junction temperature	TJ	-40 to +125	°C
Storage temperature		T _{STG}	-55 to +150	°C





<u>GREEN</u> (5-2008)

± 15 kV contact discharge ± 15 kV air discharge

- USB, 1394/firewire

- Thunderbolt

- e4 precious metal (e.g. Ag, Au, NiPd, NiPdAu) (no Sn)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

1



Vishay Semiconductors

ELECTRICAL CHARACTERISTICS (pin 1, 3, 4 or 5 to pin 2) (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	4	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	5.5	V
Reverse voltage	at I _R = 0.1 μA	V _R	5.5	-	-	V
Reverse current	at V _{RWM} = 5.5 V	I _R	-	< 1 nA	0.1	μA
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	6.9	7.5	8.7	V
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	9.5	11	V
	at $I_{PP} = I_{PPM} = 3 A$	V _C	-	12.9	15	V
Forward elemping voltage	at I _{PP} = 1 A	V _F	-	1.8	2.2	V
Forward clamping voltage	at I _{PP} = 3 A	V _F	-	3	4	V
Canacitanaa	at $V_R = 0 V$; f = 1 MHz	0	-	0.9	1	pF
Capacitance	at V _R = 3.3 V; f = 1 MHz	CD	-	0.9	1	pF
Clamping voltage	Transmission Line Pulse (TLP); $t_p = 100 \text{ ns}$, $I_{TLP} = 8 \text{ A}$	V _{C-TLP}	-	18	-	V
Clamping voltage	Transmission Line Pulse (TLP); $t_p = 100 \text{ ns}$, $I_{TLP} = 16 \text{ A}$	V _{C-TLP}	-	24	-	V
Dynamic resistance	Transmission Line Pulse (TLP); $t_p = 100 \text{ ns}$	V _{C-TLP}	-	0.93	-	Ω

APPLICATION NOTE

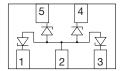
The **VBUS54FD-SD1** is a four-line ESD protection device with the characteristic of a Z-diode with a high ESD immunity and a very low capacitance which makes it usable for high frequency applications like USB 2.0, USB 3.0 or HDMI.

With the **VBUS54FD-SD1** four high speed data lines can be protected against transient voltage signals like ESD (electro static discharge). Connected to the data line (pin 1, 3 and pin 4, 5) and to ground (pin 2) negative transients will be clamped close below the ground level while positive transients will be clamped close above the 5.5 V working range. The clamping behavior of the **VBUS54FD-SD1** is bidirectional but asymmetrical (**BiAs**) and so it offers the best protection for applications running up to 5.5 V.

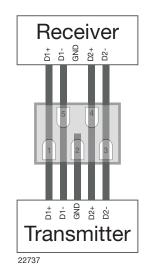
Pin configuration:

• Pin 2 is the central ground pin and has to be connected to ground

• Pin 1, 3 and 4, 5 are the inputs for the data lines D_{1+} and D_{1-} and D_{2+} and D_{2-}



22736



FLOW THROUGH DESIGN

Modern digital transmission lines can be clocked up to 480 Mbit/s (USB 2.0) or 1.65 Gbit/s (HDMI).

At such high data rates the transmission lines like cables or the line traces on the PCBs have to be very homogeneous regarding their surge impedance. This requires well defined trace dimensions as trace width and distance which have to be calculated depending on the requested surge impedance (e.g. 50 Ω) and the PCB material and layer dimensions. Any device connected to the data lines - like ESD protection devices - have to be connected with minimal changes in these trace dimensions and distances.

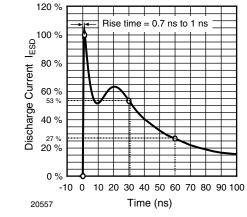
With the package in the so called "Flow Through Design" this is possible. The lines are running straight along the PCB while the **VBUS54FD-SD1** is placed on top without any vias or loops.

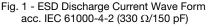
Rev. 1.3, 04-Jan-2019	2	Document Number: 82665
	For technical questions, contact: <u>ESDprotection@vishay.com</u>	
THIS DOCUMENT IS SUBJECT TO	CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HE	REIN AND THIS DOCUMENT



Vishay Semiconductors

TYPICAL CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)





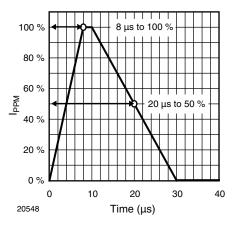


Fig. 2 - 8/20 µs Peak Pulse Current Wave Form acc. IEC 61000-4-5

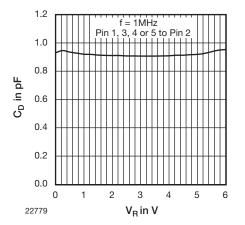


Fig. 3 - Typical Capacitance C_D vs. Reverse Voltage V_R

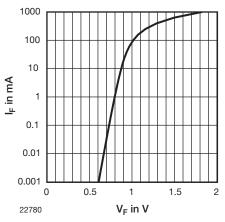


Fig. 4 - Typical Forward Current I_F vs. Forward Voltage V_F

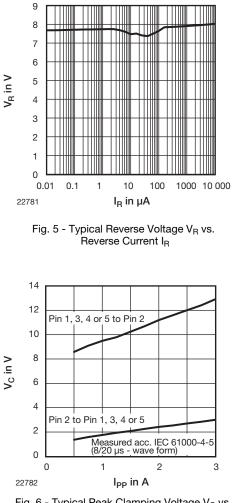
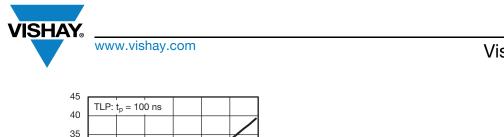


Fig. 6 - Typical Peak Clamping Voltage V_C vs. Peak Pulse Current I_{PP}

Rev. 1.3, 04-Jan-2019

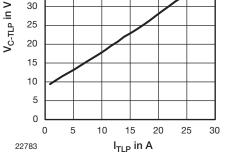
3 For technical questions, contact: <u>ESDprotection@vishay.com</u> Document Number: 82665

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



VBUS54FD-SD1

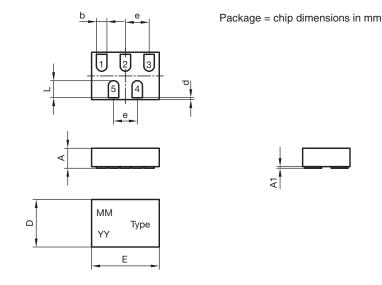
Vishay Semiconductors



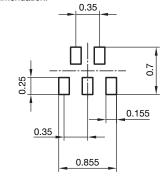
30

Fig. 7 - Typical Clamping Performance at 100 ns Transmission Line Pulse (TLP)

PACKAGE DIMENSIONS in millimeters: CLP1007-5L



foot print recommendation:



	Millimeters		
	min.	max.	
А	0.25	0.29	
A1	-	0.02	
b	0.13	0.15	
D	0.68	0.73	
E	0.98	1.03	
е	0.35		
L	0.23	0.27	
Radius	0.075		
е	0.03		

Document no.:S8-V-3906.04-041 (4) Created - Date: 11. August 2015 22857

Footprint and soldering recommendation:

please see Application Note: www.vishay.com/doc?85917

Rev. 1.3, 04-Jan-2019

4

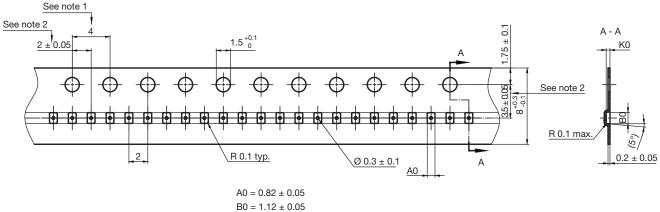
Document Number: 82665

For technical questions, contact: ESDprotection@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

Vishay Semiconductors



CARRIER TAPE in millimeters: CLP1007-5L



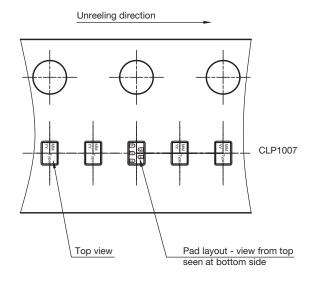
 $B0 = 1.12 \pm 0.05$ $K0 = 0.40 \pm 0.05$

Notes:

- 1. 10 Sprocket hole pitch cumulative tolerance ± 0.2
- 2. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole
- 3. A0 and B0 are calculated on a plane at a distance "R" above the bottom of the pocket

Document no.: S8-V-3906.04-042 (3) Created - Date: 23. November 2015 22858

ORIENTATION IN CARRIER TAPE: CLP1007-5L



Document no.: S8-V-3906.04-043 (4) Created - Date: 17. August 2015 22859

Rev. 1.3, 04-Jan-2019

5



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.